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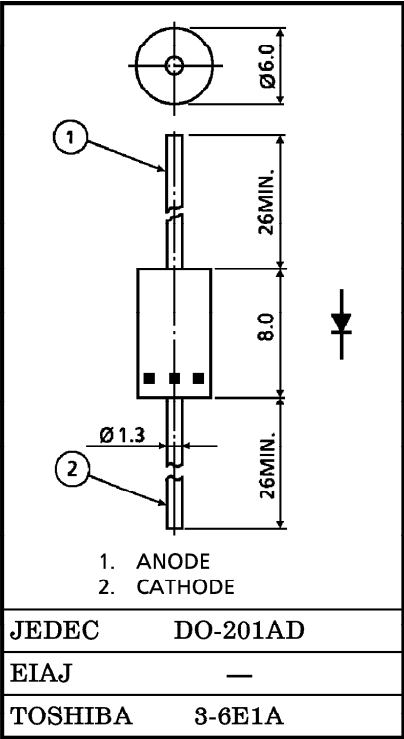
SWITCHING TYPE POWER SUPPLY APPLICATIONS

Unit in mm

- Repetitive Peak Reverse Voltage : $V_{RRM}=100\sim400V$
- Average Forward Current : $I_F(AV)=3.0A$
- Very Fast Reverse-Recovery Time : $t_{rr}=100ns$

MAXIMUM RATINGS

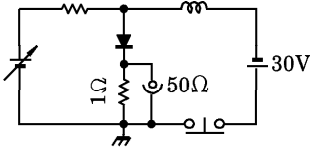
CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Reverse Voltage	V_{RRM}	400	V
Average Forward Current	$I_F(AV)$	3.0	A
Peak One Cycle Surge Forward Current (Non-Repetitive)	I_{FSM}	80 (50Hz) 88 (60Hz)	A
Junction Temperature	T_j	$-40\sim150$	$^{\circ}C$
Storage Temperature Range	T_{stg}	$-40\sim150$	$^{\circ}C$



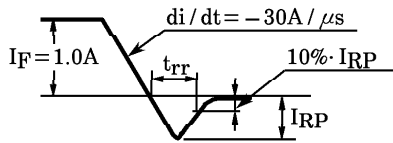
ELECTRICAL CHARACTERISTICS ($T_a = 25^{\circ}C$)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Peak Forward Voltage	V_{FM}	$I_{FM}=3.0A$	—	—	1.5	V
Repetitive Peak Reverse Current	I_{RRM}	$V_{RRM}=400V$	—	—	300	μA
Reverse Recovery Time (Note 1)	t_{rr}	$I_F=1A, di/dt=-30A/\mu s$	—	—	100	ns
Forward Recovery Time (Note 2)	t_{fr}	$I_F=1.0A$	—	—	200	ns
Thermal Resistance (Note 3)	$R_{th(j-a)}$	Junction to Ambient	—	—	37	$^{\circ}C/W$
Thermal Resistance (Note 4)	$R_{th(j-l)}$	Junction to Lead	—	—	12	$^{\circ}C/W$

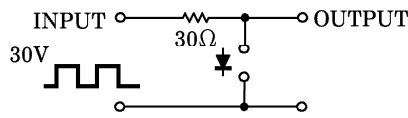
Note 1 : t_{rr} TEST CIRCUIT



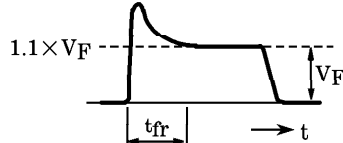
WAVEFORM



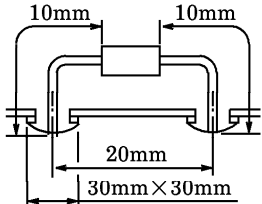
Note 2 : t_{fr} TEST CIRCUIT



WAVEFORM

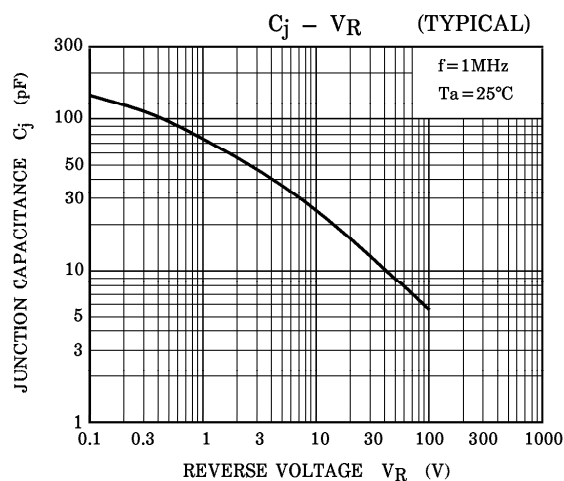
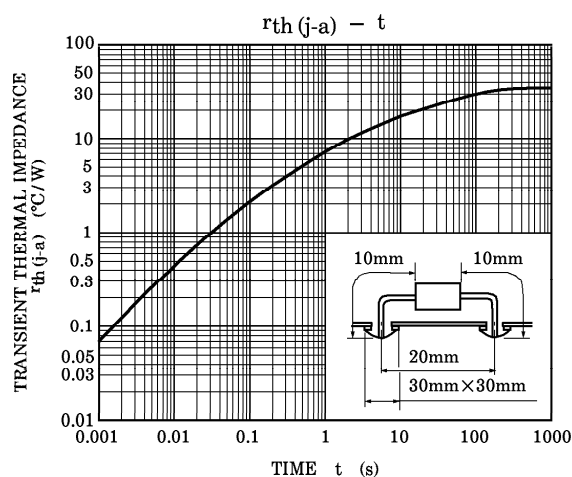
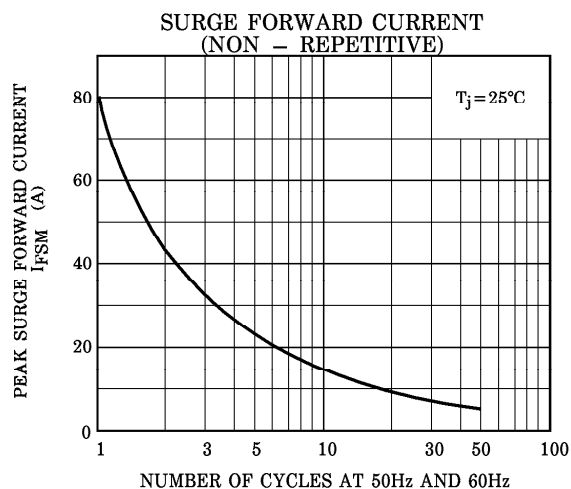
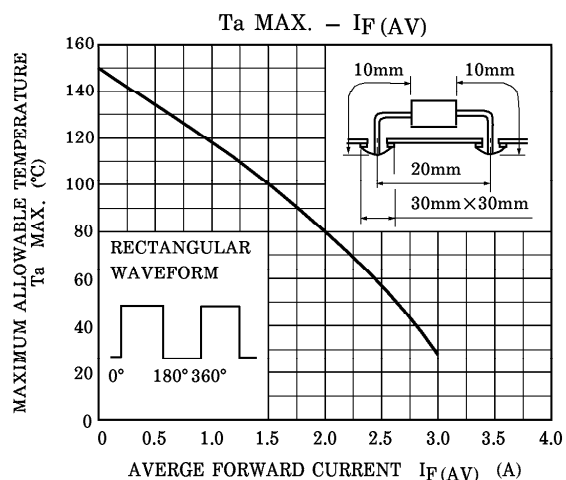
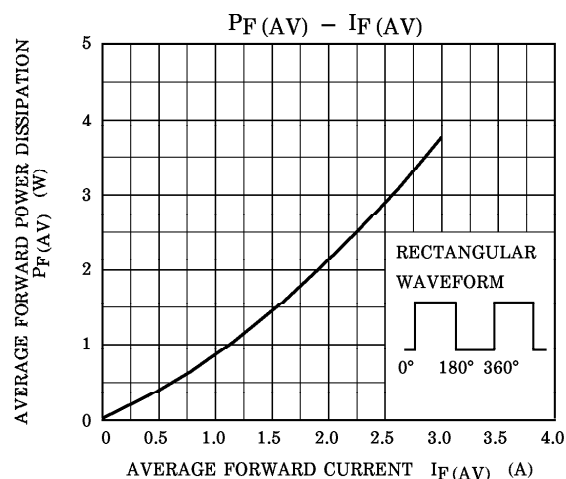
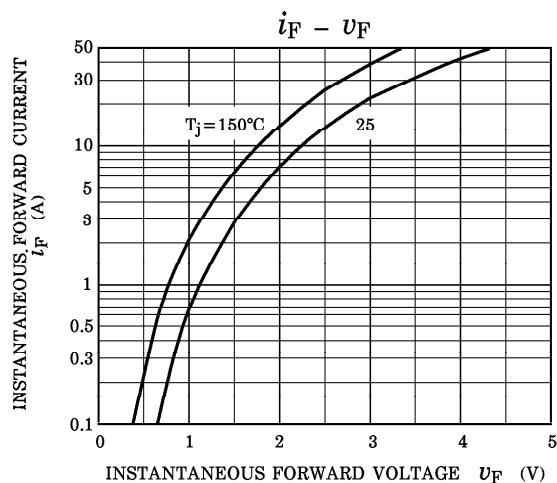


Note 3 : THERMAL RESISTANCE



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